

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Juan Antonio Diaz Martin	06/09/2008
Beatriz Escribano Arenales	06/09/2008
Maria Dolores Jimenez Bargueno	06/09/2008
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State/Country:	FRANCE
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12122795
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ATTORNEY DOCKET NUMBER:	FR2005/079 US CNT
NAME OF SUBMITTER:	Maribel Mendez
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ASSIGNMENT AND AGREEMENT

For value received and intending to be legally bound, I/we, the undersigned joint inventor(s) (Assignor(s)), sell, assign and transfer to **SANOFI-AVENTIS** (Assignee), 174 Avenue de France, Paris, 75013, France, and its successors, assigns and legal representatives, the entire right, title and interest in and to my/our invention and any improvements thereon for all countries of the world, relating in and to the application for United States Letters Patent therefor, assigned Attorney Docket No. **FR2005/079 US CNT** and (if filed prior to the execution hereof) filed on May 19, 2008, as Serial No. 12/122,795, entitled

ISOQUINOLINE AND BENZO[H]ISOQUINOLINE DERIVATIVES, PREPARATION AND THERAPEUTIC USE THEREOF AS ANTAGONISTS OF THE HISTAMINE H3 RECEPTOR


and all the rights and privileges, including any and all benefits under the International Convention for the Protection of Industrial Property, including the right to claim priority based on said United States application, and under any and all Letters Patent which may be granted therefor, and all right, title and interest in and to every patent application filed or to be filed on said invention in any other country or patent organization, including continuations, divisions, renewals, revivals, and any substitute applications of said United States application, and any and all patents which may issue thereon, and any reissues, pipelines and extensions, and governmental exclusivity rights of the same.

I/we authorize and request competent authorities to grant and issue any and all patents on said invention to said assignee or its successor, assigns and legal representatives, or to such nominees as said assignee may designate.

I/we agree that, when requested, I/we will, without charge to said assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said invention in any and all countries and for vesting title thereto in said assignee, its successors, assigns, legal representatives or nominees.

I/we covenant with said assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that I/we have full right to convey the same as herein expressed.

Signed at MADRID on this 9th day of JUNE, 2008.
(City, State and Nation)

Signature: 
Inventor's Name: Juan Antonio DIAZ MARTIN
Residential Address: 75013 Paris, France

Signed at Madrid on this 9 day of June, 2008.
(City, State and Nation)

Signature: Beatriz E.
Inventor's Name: Beatriz ESCRIBANO ARENALES
Residential Address: 75013 Paris, France

Signed at Madrid on this 9th day of June, 2008.
(City, State and Nation)

Signature: M. Jimenez
Inventor's Name: Maria Dolores JIMENEZ BARGUENO
Residential Address: 75013 Paris, France

Signed at _____ on this _____ day of _____, 2008.
(City, State and Nation)

Signature: _____
Inventor's Name: _____
Residential Address: _____

Signed at _____ on this _____ day of _____, 2008.
(City, State and Nation)

Signature: _____
Inventor's Name: _____
Residential Address: _____